MMIC REFLECTIONLESS FILTERS

 50Ω DC to 21 GHz

The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 21 GHz
- Stop band up to 35 GHz
- Excellent repeatability through IPD* process



Product Overview

Mini-Circuits' *X-Series* reflectionless filters employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages		
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.		
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.		
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.		
Excellent power handling in a tiny surface mount device	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.		
Small size, 3x3mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, saving board space.		
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.		
Excellent stability over temperature	With ±0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.		
Operating temperature up to 105°C	Suitable for operation close to high power components.		

^{*}IPD - Integrated Passive Device, is a GaAs semiconductor process



Reflectionless Low Pass Filter

XLF-662M+

50 Ω DC to 6000 MHz

Features

- Match to 50Ω in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Temperature stable, up to 105°C
- Small size, 3 x 3 mm
- Protected by US Patents 8,392,495; 9,705,467, additional patent pending
- Protected by China Patent 201080014266.1
- Protected by Taiwan Patent I581494

Applications

- Wi-Fi
- WiMax
- Microwave Radio
- Military & Space



Generic photo used for illustration purposes or CASE STYLE: DQ1225

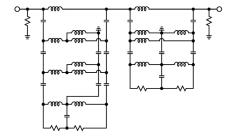
+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

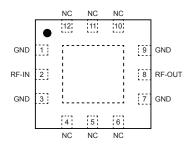


General Description

Mini-Circuits' XLF-662M+ two-section reflectionless filter employs a patented filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

simplified schematic and pad description





Function	Pad Number	Description
RF-IN	2	RF Input Pad
RF-OUT	8	RF Output Pad
GND	1,3,7,9, Paddle	Connected to ground
NC (GND Externally)	4,5,6,10,11,12	No internal connection

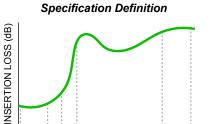
Electrical Specifications¹ at 25°C

P	arameter	F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Insertion Loss	DC-F1	DC-6000		1.3	3.1	dB
Pass Band	Frequency Cut-Off	F2	6740	_	3.0	_	dB
	VSWR	DC-F1	DC-6000	_	1.2	_	:1
	Rejection	F3-F4	9200-14000	21	30	_	dB
Stop Band	nejection	F4-F5	14000-26000	25	36	_	dB
	VSWR	F3-F4	9200-14000	_	1.3	_	
		F4-F5	14000-26000	_	1.5	_	:1

¹ Measured on Mini-Circuits Characterization Test Board TB-844-662MC+

Absolute Maximum Ratings⁴

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband ² (DC-F1) ²	5W at 25°C
RF Power Input, Stopband (F2-F5) ³	1.3W at 25°C



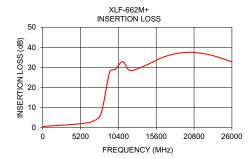
FREQUENCY (MHz)

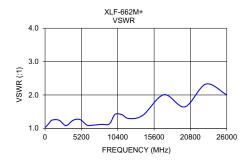
F5

F1 F2 F3

Typical Performance Data at 25°C

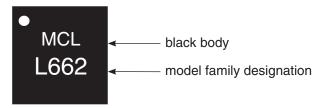
Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10	0.57	1.03
100	0.59	1.04
500	0.70	1.13
1000	0.85	1.25
2000	1.11	1.24
3000	1.30	1.08
4000	1.58	1.24
5000	1.88	1.26
6000	2.31	1.10
6740	2.99	1.09
8000	6.73	1.12
9200	27.64	1.13
10000	29.12	1.42
11000	32.89	1.41
12000	28.51	1.29
14000	30.77	1.39
17000	35.66	2.01
20000	37.51	1.64
23000	36.23	2.32
26000	32.78	2.00





Passband rating derates linearly to 2.5W at 105°C ambient
 Stopband rating derates linearly to 0.6W at 105°C ambient
 Permanent damage may occur if any of these limits are exceeded.

Product Marking

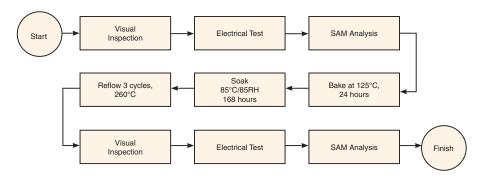


Additional Detailed Technical Information additional information is available on our dash board. To access this information click here Data Table **Performance Data** Swept Graphs S-Parameter (S2P Files) Data Set (.zip file) DQ1225 Plastic package, exposed paddle **Case Style** lead finish: matte-tin F66 Tape & Reel Standard quantities available on reel 7" reels with 20, 50, 100, 200, 500 or 1K devices Suggested Layout for PCB Design PL-451 **Evaluation Board** TB-844-662M+ (without connectors), TB-844-662MC+ (with connectors) **Environmental Ratings** ENV82

ESD Rating

Human body model (HBM): Class 1A(250 < 500V) in accordance with ANSI/ESD 5.1-2001

MSL Test Flow Chart



Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

